Review

Electron Microscopy and Spectroscopy in the Analysis of Friction and Wear Mechanisms

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Abstract: Friction and wear take place on two solid surfaces in sliding contact as a result of the mechanical, thermal and chemical interactions with the participation of environmental species. Electron microscopy and the associated spectroscopic analyses are powerful in probing these mechanisms in spatial resolutions from micro to atomic scale. This article provides a review of the author’s work in the wear and friction mechanisms of PVD hard coatings in which various SEM- and TEM-based microscopic and spectroscopic techniques were employed. Understanding on the failure mechanisms and the origin of self-adaptive friction has been improved to nano-scale. Other related issues are also discussed, such as sample preparation techniques for cross-sectional electron microscopy, energy dispersive X-ray spectroscopy and electron energy loss spectroscopy.

Keywords: electron microscopy; energy dispersive X-ray spectroscopy (EDX); electron energy loss spectroscopy (EELS); worn surface analysis; tribofilms

1. Introduction

Friction and wear are the most common phenomena in machinery and engineering practices. Wear, along with friction and corrosion, forms the major failures of engineering materials. Therefore, great efforts have been made in the control of friction and wear, including research on wear resistant coatings [1-7], hand and lubrrious coatings [8-10] and the understanding of the associated mechanisms of friction and wear [10-14]. For the latter, improved understanding on the mechanisms has been attributed to the advances in laboratory techniques of materials analyses and characterization, especially the metallographic and spectroscopic techniques based on electron microscopy. This paper is a survey of the analytical electron microscopy techniques employed in the author’s studies of wear mechanisms [14-30].

Friction and wear occurs on a solid surface when it contacts with and slides against another solid surface under pressure, in which various interactions occur. These interactions include the adhesive attraction and even cold welding, interlock between asperities and subsequent breaking, elastic and plastic deformation, conversion of shearing strain energy to frictional heating and the resulted softening, as well as sliding and friction activated chemical reactions. These interactions result in wear and material transfer along with microstructural evolution and tribo-chemical changes of the worn surfaces. In addition to these changes, the interactions also come along with dynamic variation of friction. To investigate the mechanisms of the surface material interactions, microscopic and spectroscopic techniques have long been employed as the major tool, including imaging and spectroscopic chemical analyses.

In view of imaging techniques in wear failure investigations, high-pixel camera and visual inspection are both widely applied, e.g. in assessing the wear modes at macro- and sub-millimetre scales. Optical microscopy (OM) is often employed to observe the wear phenomena of microstructure at micrometre scale [15-16]. Scanning electron microscopy (SEM), especially the high-resolution SEM equipped with field emission gun (FEG), can greatly increase the spatial resolution in microscopic observations as compare to OM. Owing to the high resolution, wear features can be observed down...
to sub-micron and nano-scales [21,24-26]. Another obvious advantage of SEM is its large depth of focus which allows sharp imaging of three-dimensional features on most worn surfaces and wear particles. Moreover, most SEM instruments also equipped with powerful capability of chemical analysis, e.g. energy dispersive X-ray (EDX) spectroscopic analysis, which enables simultaneous microscopic observation and chemical analysis of wear features [25-30]. Transmission electron microscope (TEM) is the most widely used instrument in comprehensive characterization of materials, with its advantages of the best spatial resolution in observing extremely small species and the capability in performing combined metallographic, crystallographic and spectroscopic analyses [17-22]. In addition to TEM based EDX analysis, which is superior to SEM-EDX both in the improved spatial resolution and in the increased sensibility in detecting light elements, TEM has become a platform of several advanced nano/atomic scale characterizations, such as electron energy loss spectroscopy (EELS) [14, 23, 25, 27-28]. The application of TEM in wear mechanism study is also attributed to the development of cross-sectional sample preparation, which allows characterization of worn samples from the upmost worn surface to certain depths of subsurface regions.

In the following parts, this paper will introduce the application of the analytical electron microscopy techniques, as mentioned above, in the wear mechanism studies of various nano-structured hard coatings grown by physical vapour deposition (PVD). Details of the research can be found in previous publications [14-30]. This paper will focus only on the methodology of the techniques, with a few examples to demonstrate the data interpretation.

2. Sample Materials and Tribological Tests

Several transition metal nitride coatings were developed to meet the requirements of metal-machining tools in different cutting conditions, including the binary TiN and CrN coatings, multicomponent coatings TiAIN, TiAlCrN and TiAlCrYN, and nano-structured multilayer coatings TiAlN/CrN, TiAIN/VN and TiAlCN/VCN [4, 17,23, 24, 31-32]. The coatings were grown using an industrial-scale magnetron sputtering coating equipment, each under its own optimal deposition conditions. Detailed sputtering deposition condition, microstructure characterization, mechanical and tribological properties, and industrial applications can be found in previous publications [4, 28, 31-38].

A CSM-manufactured ball-on-disc tribometer was employed in most of the tribotests [26-29]. The disc samples were the transition metal nitride coatings grown on pre-polished high speed steel coupons, which slid against a ball counterpart of either alumina ceramic or cemented WC carbide of 6 mm in diameter. The applied normal load and linear sliding speed were 5 N and 0.01 m·s⁻¹ respectively, while the tests were carried out in different time under ambient conditions.

3. Analytical Scanning Electron Microscopy

SEM is the most widely used instrument in routine materials characterization for its advantages of flexibility in sample preparation, easy data interpretation, and multiple functions of imaging, chemical analysing and the recently developed electron back scattered diffraction (EBSD). For dozens of years, SEM has been one of the essential tools in failure investigation, including comprehensive analyses of wear debris, worn samples and subsurface microstructure. In SEM, an electron beam generated in the filament, which can be tungsten, LaB₆ ceramic or a field emission gun, is focused to an extremely small size to scan over a defined area of a sample surface. During the scanning, several signals are emitted as a result of the physical interactions between the electron beam and the sample volume in the small volume beneath the beam-focused area. These signals are simultaneously collected by various detectors either to form images or to perform spectroscopic analyses.

Secondary electron (SE) imaging is the most straightforward analysis of surface morphology. Because of the very low energy, secondary electrons generated in the interaction volume are mostly absorbed by the sample matrix except those emitting from the extreme surface. Therefore, the spatial resolution of SE imaging is the best in all the SEM image modes. Also, for this reason, the SE intensity depends strongly on the geometric orientation of the electron beam scanned surface, which makes it sensitive to the variation of surface morphology. Consequently, SEM images in SE mode provide a
tool to observe the 3-dimensional morphology of rough surfaces, such as worn surfaces, fractures and chemically etched metallographic surfaces. SE imaging is the mostly used technique to observe wear products, including worn surfaces and wear debris [26, 28].

Back-scattered electron (BSE) imaging provides a tool to characterize the variation of chemical compositions in a sample. Because the energy of electrons back scattered from nuclei strongly depend on the mass density of the nuclei, the BSE intensity varies with the local chemical compositions. In other words, the contrast of a BSE image is generated from the difference in chemical compositions in the two-dimensional scanning area. In this mode, an area rich in light elements, such as oxides, carbides or nitrides, exhibits dark contrast while another area containing heavy elements exhibits bright contrast. Therefore, SEM images in BSE mode provide a convenient tool to characterize the distribution of secondary phases, the presence of oxides or other compounds [25, 29]. In addition, BSE imaging can also be employed to detect cracks and metallurgical defects, such as porosity and non-metallic inclusions [30].

Energy dispersive X-ray (EDX) spectroscopic analyses have become an essential attachment of most SEM instruments, which allows simultaneous chemical analysis during SE or BSE observation of sample features. Especially, recently developed software packages have enables several modes of SEM-EDX analyses. When the incident electron beam is fixed at a point or defined to scan within a special area or line, a spectrum can be obtained, from which the chemical compositions of the electron-hit point or area can be determined either qualitatively or quantitatively. Using the SEM-EDX spectroscopic analysis, it is convenient to analyse the overall chemical composition of a sample or the chemical compositions of various areas. In interpret an obtained EDX spectrum, one should bear in mind about the overlapping characteristic X-rays, such as the overlaps between N-K and Ti-L, O-K and Cr-O as well as V-L. A few examples will be discussed later. If the analysis is paid more attention on one or more elements in an imaged area, the line-scan mode is operated by confining the scanning electron beam in a defined length, e.g. across a grain boundary or an object of interest, to get the relative (qualitative) profiles of the selected elements. Similarly, the scanning can be made in a pre-defined area, instead of a period of length, to obtain a two-dimensional relative distribution of the featured elements, known as element-mapping analysis [30].

SEM-EDX analyses provide reasonable accuracy to the analyses of heavy elements, e.g. most metals in the periodic table. However, its accuracy is greatly restricted in the analysis of light elements, i.e. from boron to oxygen in the periodic table. The characteristic X-rays of these light elements have very low energies, which makes them mostly absorbed by the sample matrix except the X-rays emitting from the outmost surface. Consequently, the integrated intensities of these X-rays are much lower than the characteristic X-rays of heavier elements, because the latter emit both from the outmost surface and from certain depth (up to several micrometres). Although SEM-EDX is less sensitive in analysing light elements, nevertheless, it provides the feasibility to detect dissimilar matters, such as tribo-oxidation films or particles as compared to the bulk worn surface. Another limitation of SEM-EDX is the scattering data in analysing carbon element, which arises from the unavoidable presence of carbon contamination of samples.

Given these functions as described above, SE imaging is normally used to observe the morphology of worn surfaces and wear debris, from which the wear modes and wear mechanisms are determined. BSE imaging is applied to distinguish the regions of different chemical compositions on the worn surfaces analysed, such as the products of tribo-chemical wear and transferred matter from the counterpart. Then SEM-EDX spectroscopy and related line scanning and 2-D mapping provide more accurate analyses of the chemical compositions.

In addition, SEM can also be employed to characterise the microstructure changes in a depth of a worn surface [30, 39]. This analysis is achieved by preparing a vertical cross-section of the worn surface. Consequently, the SE and BSE imaging can be applied to investigate wear induced changes in the microstructure, such as deformation, cracking, delamination, transferred layer and intermixing, and tribofilm formation. The experimental procedure of cross-sectional sample preparation will be described later.

4. Analytical Transmission Electron Microscopy
TEM is the most widely used instrument in comprehensive microstructural characterization owing to its best spatial resolution and powerful imaging, diffraction and spectroscopic analyses. In TEM, a high energy, mono-wavelength and parallel electron beam transmits through a well-prepared thin foil crystalline sample to generate elastic scattering and inelastic scattering of electrons. Meanwhile, the interaction between the sample foil and the transmitting electron beam also results in emission of characteristic X-rays from the interaction volume of the sample. In the so-called diffraction mode, the elastic scattered electron beam is processed using a series of lens to form bright field (BF) and dark field (DF) images to show microstructural features, including grains and grain boundaries, crystalline defects and fine precipitates. Selected area diffraction (SAD) allows crystallographic analysis to be performed in a defined small sample volume. TEM is also capable of resolving the atom stacking structure at extremely high magnification when it is operated in the so-called phase-contrast mode, i.e. high-resolution electron microscopy (HREM). HREM possesses the best spatial resolution in microscopic observations, which can be applied to make lattice imaging, e.g. the ordered atomic stacking, dislocations and stacking faults, and short-range ordered domains in amorphous and nanocrystalline samples [21, 27, 28].

TEM can perform chemical analyses in micro- and nano-scales by means of EDX and EELS. In TEM-EDX analysis, the characteristic X-rays emitted from the electron-sample interaction volume are collected by a detector positioned in close vicinity of the sample. Then EDX spectroscopic analysis is performed to determine the chemical composition, whereas TEM-EDX is superior to SEM-EDX in that it can analyse the composition of an area as small as only a few nanometres in diameter. Furthermore, the capability in analysing light elements is enhanced owing to the elimination of mass absorption of the low-energy X-rays [22,23, 29]. In advanced analytical TEM, the incident electron beam can be configured to scan over the sample, to achieve the functions of line-scan and elemental mapping.

EELS is another TEM based spectroscopic chemical analysis. Unlike TEM-EDX which analyses the characteristic X-rays directed from the electron interaction volume, the principal of TEM-EELS analysis is based on the fact that the emission of a characteristic X-ray signal corresponding to a specific energy band of an element is accompanied by the same amount of energy loss in the transmission electron beam [14, 40]. The electrons with the decreased energy form inelastic scattering. Then a special prism lens is fitted to translate the transmission beam into a spectrum, in which the intensity of the electron beam is displayed as a function of the actual energy, or energy loss as compared to the energy of elastic scattered electron beam. EELS is superior to EDX in at least two aspects. Firstly, it totally overcome the drawback of mass absorption in the EDX analysis of light elements, because the actual electron intensity reflects the transmission electron beam instead of the extremely weak signals of X-ray emission. Therefore, a distinct edge of energy loss can be obtained from every detected light element. Secondly, EELS analysis has more than ten times better energy resolution than EDX analysis, which allows the separation of the characteristic edges having very close energy levels. For example, the N-K and Ti-L edges can be easily separated in EELS analysis. Moreover, the extremely high energy resolution of EELS makes it possible to conduct a more precise analysis on the shape of a characteristic energy edge, for the edge shape is strongly influenced by the chemical environment of the analysed element. Such analysis is called energy loss near edge structure (ELNES). For example, TEM-EELS was applied to identify sliding induced transition of carbon from sp3 to sp2 bond [41] and to separate stoichiometric and sub-stoichiometric nitrides as well as other chemical structures [42-47]. In addition to the functions of spectroscopic chemical analyses, TEM-EELS is also able to show the 2-dimensional distribution of elements, which is known as energy-filtered imaging, i.e. element mapping at TEM-scale resolution [27, 40, 43].
5. Sample Preparation for Wear Mechanism Study

Wear mechanism study by electron microscopy relied on well-prepared samples, including wear debris, worn surface and cross-sections of worn surface. For wear debris, the sample preparation is relatively easy except that the debris should be separated from other artificial contaminants, such as grease, oil and aqueous species. A straightforward way to remove these contaminants is cleaning the debris samples in some solvents, such as acetone. Then the cleaned and dried debris can be dropped on an electrically conductive tab to proceed to SEM based imaging and spectroscopic analyses. Wear debris can also be analysed directly on TEM without any special sample preparation. Perhaps the only limitation is the thickness or size of wear debris, that the thickness of an individual wear debris particle must be small enough, e.g. less than 50 - 100 nm, to make it transparent to the transmission electron beam. Prior to TEM observation, a normal preparation procedure of debris sample includes diluting the fine powder in a volatile solvent, such as acetone, then dropping the powder-solvent mixture onto a carbon-filmed TEM sample grid. Then the TEM sample is ready for analysis. A few examples of SEM and TEM analyses of wear debris can be found in the publications [21, 23, 26, 27].

As-obtained worn surface is the mostly used sample for wear mechanism study owing to the availability of SEM in most laboratories of materials research. An important preparation stage prior to analysis is cleaning, i.e. to remove all the environment-induced contaminant. This is performed normally using a volatile solvent, in some cases with ultrasonic vibration to enhance the cleaning process.

Most wear features observed on the worn surface, such as scratches and ploughing grooves, cracks and spallation, as well as transferred layers, are related to the thermal, mechanical and or chemical changes in certain depths of the worn sample. Consequently, cross-sectional microscopy has been a very useful analytical method to observe the subsurface microstructure phenomena related to the surface features. For example, the ploughing deformation observed on a worn surface is often related to plastic deformation in certain depth beneath the ploughing grooves [27, 29, 30]. In some cases, such surface deformation may already result in nucleation of delamination cracking, which is only visible by using the cross-sectional observation [17-19].

Cross-sectional microscopic observations of worn materials were developed long time age, e.g. before 1990s in cross-sectional OPM to study the wear mechanisms of cast irons and steels [48-50]. In that time, a special need in the cross-sectional sample preparation was to ensure the worn surface edge being aligned in the same plane as the bulk sample, i.e. to eliminate the polishing induced edge curvature. This is because of the extremely restricted focus depth of OPM. In the preparation, a cross-sectional worn surface sample was mounted in Bakelite. Because of the mismatch of hardness between the sample and the relatively softer mounting material, preferential wear often occurred in the Bakelite, which triggered the formation of a small curvature in the extreme surface edge. As a result, it became impossible to focus the outmost surface edge and the bulk sample simultaneously, greatly affecting the OPM observation. This problem was overcome by attaching a small piece of metal, having the same hardness as the sample, closely on the worn surface. Consequently, the counterpart metal and the sample maintained the same wear rate, leaving a very sharp worn surface edge to facilitate OPM observation. This technique has also been applied in preparing cross-sectional samples for SEM observation and in the grinding stage of cross-sectional TEM samples.

Two methods have been developed to prepare cross-sectional TEM samples of worn surfaces, namely the low-angle ion milling method and focused ion beam (FIB) method. The former relies on the use of an ion beam milling equipment, such as the precise ion polishing system (PIPS, model Gatan 691) which is available in many electron microscopy laboratories. The second one is accomplished in a special model of SEM, a dual-beam SEM with integrated FIB facility to perform in-situ sectioning during SEM imaging. Up to date, such preparation techniques have been documented in literature by many authors [51-56]. In this paper, the author only intend to discuss the special precautions for cross-sectional samples of worn surfaces.

The author has used the low-angle ion milling method in previous TEM work [14-26, 28, 31, 37-39]. Figure 1 illustrates the preparation of a cross-section TEM sample from a worn surface. The preparation starts from cutting a small rectangular piece from the worn sample, typically 2 - 3 mm in
length and 1 mm in width and with its long edge parallel to the wear direction for easy characterization of wear induced microstructure changes such as grain bending and delamination. Then after mounting the sample on a flat glass plate using a thermoset wax, one can start manual grinding on a metallographic grinding paper. In this step, it is important to keep the abrasives slid only in the direction vertically from the worn edge to the bulk sample. Such abrasion will only act on the worn edge with a compressive load, which prevents cracking and spalling of the worn surface layer. Such unidirectional grinding also helps prevent the loss of worn surface attachments, such as loosely attached tribofilms. By grinding from both sides, the sample reaches a thickness of 30 - 50 µm before it is dismounted from the glass and cleaned in acetone. Then the cleaned specimen is mounted using epoxy resin on a standard slot grid for ion milling polishing on a PIPS instrument.

![Image](image-url)

**Figure 1.** The procedure of sample cutting in preparing a cross-section TEM foil sample: (a) A typical ball-on-disk wear scar; (b) A high-magnification SEM image taken in the smooth area of the worn surface, seeing the highlighted area in (a); (c) A schematic draw to show the positions of cross-sectional SEM and TEM samples; (d) A schematic draw to show a grinding-thinned worn cross-section is glued on a TEM slot grid.

Another special need is to prepare an indicative mark of the outmost worn surface of the prepared sample. In FIB-SEM preparation, a special metal, normally platinum, is deposited on the selected sample area before ion beam cutting. Then the outmost worn surface can be easily recognised just beneath the platinum layer. For the low-angle ion milling preparation, there is no need to deposit such a metal layer. However, a layer of metal deposit is naturally generated accompanying the thinning of the specimen. The mechanism is that, whereas the specimen is polished from its both sides by the ion beam sputtering, the sputtered species both from the bulk specimen and from the copper grid will re-deposit on the outmost surface edge of the cross-section. The thickness of the re-deposited layer increases with the polishing time, which makes it distinctly different from the specimen area in TEM observation. Consequently the re-deposit can serve as a guide of the outmost worn surface, where various worn surface features are well embedded on the top, including wear induced deformation and delamination, tribofilms, and even loose wear debris. Finally, it is
important to make a final cleaning when a thin foil specimen is prepared. The aim of the cleaning is
to remove the re-deposited species on the sample area. The cleaning is completed by turning the two
ion guns of the PIPS instrument to a higher angle of $10^\circ$ and running at low energy of 2 - 3 keV
for up to 1 minute. Then the specimen foil to be observed in TEM will be clean at atomic scale, free
from any contaminant dots.

6. A Few Examples

6.1. FEG-SEM Observation on the Running-in Friction

Previous research has revealed the effect of chemical composition and relative humidity (RH)
on the friction and wear properties of transition metal nitride coatings in unlubricated pin-on-disk
wear tests [23, 28, 32]. Figure 2 shows a collection of some obtained results of average coefficients of
friction and wear for a number of coatings. The tests were undertaken at different times and under
the same conditions of applied load 5N, linear sliding speed 0.01 m $\cdot$ s$^{-1}$, room temperature at two
levels of RH (27% and 66% respectively), and against an alumina ball of 6 mm in diameter. The
coatings were grown on pre-polished high speed steel M2 using unbalanced magnetron sputtering.
Prior to the sputtering deposition, the samples were ion-etched to enhance the coating-substrate
adhesion property using either cathodic arc or high [4, 28]. In Figure 1a, the vanadium-containing
coatings TiAlN/VN and TiAlCN/VCN show low coefficients of friction between 0.38 and 0.5 when
the tests were undertaken at high RH (66%). Their coefficients of friction became higher, increased to
around 0.6, when the RH value was low (27%). The TiAlCrYN coating, however, exhibited high
coefficients of friction 0.65 – 0.7 regardless of the RH values. Correspondingly, the coatings exhibited
different coefficients of wear, Figure 1b. In general, low friction has been found to contributed to low
wear rate.

Figure 2. The friction and wear properties of various transition metal nitride coatings in unlubricated
pin-on-disk tribotests: (a) average coefficient of friction; and (b) coefficient of wear.
Extensive worn surface analyses revealed the existence of thin tribofilms on the worn surfaces, which strongly adhered to the worn nitride surfaces and replaced the latter in the direct sliding contact. Consequently the tribofilms eventually determined the coefficient of friction. A series of interrupted sliding wear tests were designed to correlate the variation of friction to the evolution of the sliding contact zone, i.e. the worn surface. Figure 3 shows an example of the running-in friction curves. In the experiments, the tribotests were terminated at total sliding periods of 10, 20, 100, 500, and 1,000 cycles to obtain a series of wear tracks for examination. Details of the results have been published elsewhere [25, 26], whereas a few typical images are presented in this paper to demonstrate the use of high-resolution SEM in the wear mechanism study.

![Figure 3](image_url)

**Figure 3.** The running-in period of the friction curve of a TiAlN/VN coating measured in an unlubricated pin-on-disk sliding test versus an alumina ball. The ‘X’ marks in the curve denote the terminating points for SEM observation of worn surface, namely, 10, 20, 100 and 500 sliding cycles.

Figures 4-6 provides the application of SEM SE imaging in the observation of worn surfaces. The imaging mode has very powerful spatial resolution in resolving nano-scale features owing to the field emission gun and the SE imaging mode.

![Figure 4](image_url)

**Figure 4.** A high magnification FEG-SEM image taken at the boundary of the 100-sliding-cycle wear track to show the as-deposited coating surface.
Figure 5. High magnification FEG-SEM SE images showing the evolution of TiAN/VN wear debris after different sliding cycles against a WC counterpart ball: (a) 10 cycles; (b) 100 cycles; (c) 10,000 cycles and (d) 100,000 cycles.
The micrograph in Figure 4 delivers two important features, namely the nano-scale cellular-like growth front of the coating and the preferential wear of a large defect grain. The cellular-like cells refer to columnar grains when the coating was grown under a relatively low substrate bias voltage. Hard coatings with such rough surface refer to dense columns with sub-dense column boundaries, which favours relatively low residual compressive stresses and promise better wear performance when the coating is deposited on a machining tool [22]. With respect to the sliding wear, such nano-scale rough surface facilitate asperity contacting mode in the beginning of the pin-on-disk tribotest. In other words, the applied normal and tangential loads were applied on only a small portion of the nominal contacting area, so that high concentrated loads were applied on a limited number of column grain tops to result in breakage, fracture and spalling wear of these nitride grains. Secondly, a large growth defect grain in the middle of the imaged area had been flattened by wear, seeing the area labelled with a ‘X’ mark. The small flat worn area is adhered with a transferred layer of the counterpart material, WC cemented carbide. Some agglomerated fine WC particles adjacent to the worn area. The small worn area provided an evidence of the initial wear caused by asperity contact between the coating surface and the counterpart ball. Such asperity contacts took place only at a limited number of contacting points, and thereafter resulted in highly concentrated contact stresses.

The micrographs in Figure 5 were taken on the edges of wear tracks after various selected sliding cycles to demonstrate the evolution of wear debris with increasing sliding cycles. The initial wear particles are in sub-micron scale, which were caused by breakage of the column tops as described above. Some of the initial particles were accommodated along the wear track edge whereas some were entrapped into the sliding contact zone to subject to further breaking and powdering. In Figures 5 a-d, the wear particles can be seen to be increasingly smaller when the sliding proceeded to more cycles, most of them eventually becoming nano-scale agglomerates.
The micrographs in Figure 6 demonstrate the generation of tribo-oxide films on the worn surface with increasing sliding cycles. Initially dispersive nanoscale attachments formed on the worn surface, Figure 6a. These extremely fine attachments are nitride debris which strongly adhered to the worn surface because of the strong ionic bonding of the transition metal nitride. The attachments increased in amount and in continuity with the increased sliding cycles, seeing Figures 6 b-c, and eventually generated a continuous film, seeing Figure 6d. The tribofilm exhibit fish-scale morphology. Such morphology suggests adhesive flow of the tribofilm being driven by the tangential load, in which the responsive frictional resistance depends strongly on the shear resistance of the tribofilm. More details about the formation of tribofilms have been published elsewhere [26]. In addition to the adhesive attachments and tribofilm, Figure 6 also shows some loose debris rods. These rods, along with the edges of the fish-scales, exhibit bright contrast due to the concentrated generation of secondary electrons. Previously the FIB technique was employed to prepare a cross-sectional TEM foil to characterize the structure and chemistry of such rods. The rods were found to be amorphous multicomponent oxide of the TiAlN/VN nitride [21].

Figure 7 demonstrates the application of SEM BSE and SE imaging modes and EDX analysis in the characterization of tribo-oxide products. The images were taken on the worn surface of a TiAlCN/VCN coating generated after about 150,000 cycles of unlubricated sliding against an alumina ball. Details of the coating deposition and the tribological properties have been published elsewhere [28].

Figure 7. Analysis of worn surface and tribofilm by means of three SEM modes: (a) the SEM SE imaging mode; (b) SEM BSE imaging mode; (c, e) the SEM-EDX spectroscopic analysis of tribofilm; and (d,f) the SEM-EDX spectroscopic analysis of the worn nitride surface.
In the SE image, Figure 7a, the imaged area shows mainly two levels of contrast. The smooth worn surface of the nitride exhibits grey contrast whereas a piece of tribo-oxide film exhibits dark contrast. The different contrast derived from the fact that these two areas emitted different amounts of secondary electrons, i.e. stronger SE signals were generated in the nitride area than in the tribo-oxide area. The significant difference in the SE emission implies different chemical structure of the tribofilm to the nitride.

In the BSE image, Figure 7b, the tribofilm exhibits slightly brighter contrast than the nitride worn surface, which reflects the similarity in the mass density between the nitride and the tribo-oxide. Moreover, the tribofilm also shown fine features, which suggests the discontinuity in mass considering its nature in the dynamic formation by repeated shear deforming and agglomerating. The dark-contrast areas in the tribofilm can be then interpreted as the porous volumes in the tribofilm.

Figures 7c-f show the comparative SEM-EDX analysis of the two regions. The only difference between the two regions is in the low-energy period of the spectra, i.e. the presence of light elements O and N. So the profiles of the light element spectra are highlighted to show more details in better energy resolution. In the spectra of the nitride worn surface, Figures 6d and f, the spectroscopic peak is dominated by N-K although lower intensity C and O are also within the peak width. The low-energy peak of the tribofilm, Figures 7c and 7e, seems to be overlapped subpeaks of N-K and O-K, which can be interpreted as the occurrence of tribo-oxidation.

In Figures 7c-f, the limitation of EDX analysis is obviously in the poor energy resolution. In the acquisition, the whole band of 10 keV is accommodated in about 1,000 channels, which derives a resolution of approximately 10 eV per channel. Considering the factor of peak broadening, such poor resolution is unable to separate the characteristic X-rays of N-K (392 eV), Ti-L (452 eV), V-L (511 eV) and O-K (525 eV). More comprehensive characterization is available in TEM-EELS analysis, to be discussed in later section.

6.2. TEM, EDX and EELS Analysis of Tribofilms

Using TEM to analyse the tribofilm on a worn surface, the first step is to prepare a cross-sectional TEM sample. The sample shown in this study was a worn surface of a magnetron sputtered TiAlN/VN multilayer coating which was tested in a ball-on-disc dry sliding wear against an alumina ball [14, 22-24] after 200,000 sliding cycles. The cross-sectional TEM foil sample was prepared through a procedure from manual grinding and polishing to ion milling using a PIPS instrument (Model: Gatan 691). A typical cross-sectional TEM bright field image is shown in Figure 8. As described before, the top edge of the image is a layer of copper redeposit generated by sputtered sample materials (including the slot copper grid, the steel substrate as well as the nitride coating). Then beneath the copper redeposit is the whole section of the tribofilm and the top part of the TiAlN/VN coating. Each part has been clearly labelled in Figure 8.
Figure 8. A cross-sectional TEM bright field micrograph of the worn TiAlN/VN multilayer coating, showing the whole thickness of a tribofilm attached on the worn TiAlN/VN top.

Full details of the scientific findings of the research can be found in previous publications [14, 22, 23]. The focus of this paper is mainly on the interpretation of the acquired EDX and EELS results.

The TEM-EDX spectra in Figure 9 were acquired in various areas of a cross-sectional sample and a wear debris sample using the EDX analyser attached to the Philips CM20 TEM. The electron beam was focused to a size of about 9 nm in nominal diameter. Similar to SEM-EDX analysis, the spectra show strong K peaks of metal elements V, Ti and Al. The Cu peaks derived from the surrounding copper medium, i.e. the sample holder and the copper-redeposit. However, the attention of the analysis was paid on the signals of light elements, O and N in the low-energy range. The low-energy peak of N-O-Ti-V in the TiAlN/VN spectrum is very low, in which the actual fraction of oxygen should be marginal because of the considerable contributions of N-K, Ti-L and V-L, Figure 9a. Then the low-energy peaks become substantially stronger in the spectra of the tribofilm and wear debris, especially in the latter, Figures 9 b-c. The striking difference implies increasing amount of oxygen in the tribofilm and wear debris. This has been confirmed by resolving the spectrum of the wear debris to the best energy resolution, Figure 9d, where the maximum point of the peak corresponds to the energy level of O-K.

Figure 9. TEM-EDX spectra acquired in the cross-sectional worn TiAlN/VN samples: (a) in the TiAlN/VN multilayer; (b) in the tribofilm; and (c-d) in the wear debris.
In Figure 10, selected EELS patterns are illustrated to interpret the chemical characteristics of the nitrides TiAlN/VN and VN, the tribofilm and the wear debris. These patterns were acquired in the same samples as those in Figure 8. Several important features should be addressed. Firstly, the EELS exhibit much higher energy resolution than EDX spectroscopy that the energy edges of N-K, Ti-L, V-L and O-K are well separated to each other. Note that the whole energy width in each pattern is only 250 eV, much smaller than the corresponding EDX spectra. Thus, EELS makes it possible to feature the different presence of N, O, given their very close energy bands to the Ti-L and V-L bands. Secondly, EELS exhibits its great sensibility in detecting light elements. In the patterns, both N and O show distinct and strong energy edges with substantial intensities as compared to the edges of metal elements. However, the EELS patterns of TiAlN/VN and VN show N-K edge only, but no O-K edge. On the other hand, the O-K edges in the tribofilm and wear debris are fairly strong, indicating the occurrence of tribo-oxidation. Note that the N-K band in Figure 10d is flattened, indicating complete oxidation of the wear debris. Thirdly, the high energy resolution of EELS facilitate detailed comparison of an energy edge shape between different chemical compounds, i.e. the energy loss near-edge structure or ELNES. It is worthwhile to compare the N-K edge in the three patterns. The N-K edge of the VN and TiAlN/VN, both being stoichiometric nitrides, shows two sharp peaks at the energies of 400 eV and 420 eV respectively and one broad peak at 430 eV. In the N-K of the tribofilm, only the first peak remains the similar shape whereas the other two peaks became less than half the intensity of the stoichiometric nitrides. According to literature of similar EELS analysis, such modified ELNES suggests loss of nitrogen in the compound, i.e. the nitride becoming sub-stoichiometric. In other words, the nitrides in the tribofilm were in an intermediate chemical state of the tribo-oxidation.

Figure 10. TEM-EELSacquired in the cross-sectional worn TiAlN/VN samples: (a) in the TiAlN/VN multilayer; (b) in the tribofilm; and (c-d) in the wear debris.
6.3. XTEM of Wear Induced Subsurface Microstructure Changes

In sliding wear, the applied normal and tangential loads are known to cause plastic deformation of the surfaces in sliding contact, which resulted in hardening due to dislocation interactions and softening due to frictional heating depending on the applied conditions. Delamination wear is often observed to take place in the deformed layer as a result of the deformation induced hardening. The depth of deformation depends strongly on the hardness of the worn surface. As stated before, cross-sectional microscopy provided an effective method to characterize such wear failure by observing the resultant microstructural evolution from the outmost surface to certain depth. In case of PVD hard coatings in which the depth of deformation is within sub-micron or nano-scales, cross-sectional TEM has often been applied to study such wear mechanisms. In preparing such cross-sectional TEM foil, it is important to take great care in the manual grinding stage of sample preparation to prevent any artificial damage of the sample, e.g. avoiding cracking and spalling of the original worn surface edge. Also it should be strictly prohibited to have the ion beam bombard the worn surface in the PIPS ion milling stage. Then the real worn surface features can be retained for the TEM observation. In addition, the observed foil area should be thin enough to ensure high quality of TEM observation.

Some examples are provided in Figure 11. Detailed experimental work has been published elsewhere [17-19, 57]. Figures 11 a-c were taken from the worn surface of a TiAlCrYN coating when the prepared cross-sectional foil sample was observed using a high-voltage JEOL 3010 TEM at 300 KV. The high accelerating voltage facilitated observation of relatively thick sample. The worn surface deformation can be seen to have taken place in a depth of sub-micron scale, seeing the bended columnar grains towards the sliding direction (indicated by an arrow in Figure 10a). Comparing to the BF imaging, a better way is the use of dark field imaging to highlight the bending deformation of the columnar grains, e.g. comparing Figures 11 b and c. The delamination cracks were easy to recognize because of the much higher brightness than the coating matrix caused by direct transmission of electron beam. Figures 11 d-e are cross-sectional TEM images of a multilayer coating TiAlN/CrN. The images were taken using a Philips CM20 TEM working at 200 KV. The BF images show wear induced bending deformation, cracks and a nanoscale delamination sheet.

![Figure 11](image-url)
7. Summary

Electron microscopy and associated spectroscopic analyses provide a powerful tool in the comprehensive characterization of wear products, including worn surfaces and wear debris, which make significant contribution to the understanding of the wear and friction mechanisms.

Of these, SEM based imaging and spectroscopic analyses are straightforward in assessing worn surfaces and wear debris, where FEG-SEM is capable of observing wear induced features in up to nano-scale and the BSE imaging and EDX spectroscopy are applied to deal with tribo-chemical wear. TEM based wear mechanism study has been attributed to the successful preparation of cross-sectional worn surface samples using the ion beam milling techniques. On the prepared cross-sectional samples, TEM provides sufficiently high spatial resolution in observing wear induced microstructure changes in certain depths of the worn surface layer, including tribofilms and other types of worn surface attachments. More importantly, TEM has been a very useful platform to combine BF and DF imaging, SAD, EDX, EELS and ELNES in the multiple analyses of wear mechanisms.

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References


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